

Product Overview

The NSi812x devices are high reliability dual-channel digital isolator. The NSi812x device is safety certified by UL1577 support several insulation withstand voltages (3.75kVrms, 5kVrms), while providing high electromagnetic immunity and low emissions at low power consumption. The data rate of the NSi812x is up to 150Mbps, and the common-mode transient immunity (CMTI) is up to 150kV/us. The NSi812x device provides digital channel direction configuration and the default output level configuration when the input power is lost. Wide supply voltage of the NSi812x device support to connect with most digital interface directly, easy to do the level shift. High system level EMC performance enhance reliability and stability of use. AEC-Q100 (Grade 1) option is provided for 3.75kV parts.

Key Features

- Up to 5000V_{RMS} Insulation voltage
- Data rate: DC to 150Mbps
- Power supply voltage: 2.5V to 5.5V
- AEC-Q100 Grade 1 available for SOIC-8
- High CMTI: 150kV/us
- Chip level ESD: HBM: ±6kV
- High system level EMC performance: Enhanced system level ESD, EFT, Surge immunity
- Default output high level or low level option
- Isolation Barrier Life: >60 years
- Low power consumption: 1.5mA/ch (1 Mbps)
- Low propagation delay: <10ns

- Operation temperature: -40°C~125°C
- RoHS-compliant packages: SOIC-8 narrow body SOIC-16 wide body

Safety Regulatory Approvals (pending)

- UL recognition: up to 5000V_{RMS} for 1 minute per UL1577
- CQC certification per GB4943.1-2011
- CSA component notice 5A approval IEC60950-1 standard
- DIN VDE V 0884-10 (VDE V 0884-10): 2006-12

Applications

- Industrial automation system
- Isolated SPI, RS232, RS485
- General-purpose multichannel isolation
- Motor control

Functional Block Diagrams

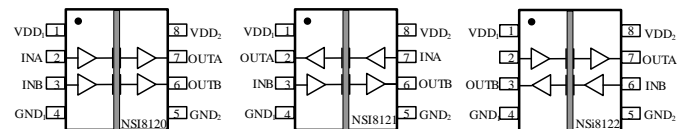


Figure 1. NSi812xN Block Diagram

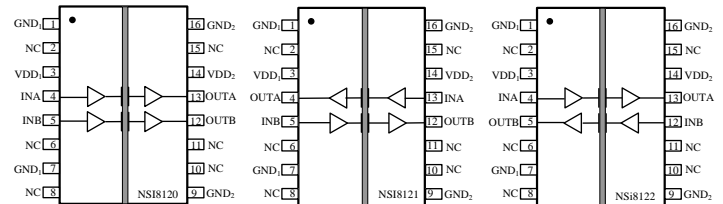


Figure 2. NSi812xW Block Diagram

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CONFIDENTIAL

NSi8120/NSi8121/NSi8122

1.0 ABSOLUTE MAXIMUM RATINGS

Parameters	Symbol	Min	Typ	Max	Unit	Comments
Power Supply Voltage	VDD1, VDD2	-0.5		6.5	V	
Maximum Input Voltage	VINA, VINB	-0.4		VDD+0.4	V	
Common-Mode Transients	CMTI	-150		150	kV/us	
Output current	I _o	-15		15	mA	
Maximum Surge Isolation Voltage	V _{IOSM}			10	kV	
Operating Temperature	T _{opr}	-40		125	°C	
Storage Temperature	T _{stg}	-40		150	°C	
Electrostatic discharge	HBM			±6000	V	
	CDM			±2000	V	

2.0 SPECIFICATIONS

2.1 ELECTRICAL CHARACTERISTICS

(VDD1=2.5V~5.5V, VDD2=2.5V~5.5V, Ta=-40°C to 125°C. Unless otherwise noted, Typical values are at VDD1 = 5V, VDD2 = 5V, Ta = 25°C)

Parameters	Symbol	Min	Typ	Max	Unit	Comments
Power on Reset	VDD _{POR}		2.2		V	POR threshold as during power-up
	VDD _{HYS}		0.1		V	POR threshold Hysteresis
Input Threshold	V _{IT}		1.6		V	Input Threshold at rising edge
	V _{IT,HYS}		0.4		V	Input Threshold Hysteresis
High Level Input Voltage	V _{IH}	2			V	
Low Level Input Voltage	V _{IL}			0.8	V	
High Level Output Voltage	V _{OH}	VDD-0.2			V	I _{OH} ≤ 4mA
Low Level Output Voltage	V _{OL}			0.2	V	I _{OL} ≤ 4mA
Output Impedance	R _{out}		50		ohm	
Start Up Time after POR	tr _{bs}		3		usec	
Common Mode Transient Immunity	CMTI	100	150		kV/us	

NSi8120/NSi8121/NSi8122

(VDD1=5V± 10%, VDD2=5V± 10%, Ta=-40°C to 125°C. Unless otherwise noted, Typical values are at VDD1 = 5V, VDD2 = 5V, Ta = 25°C)

Parameters	Symbol	Min	Typ	Max	Unit	Comments
Supply current	NSi8120					
	I _{DD1} (Q0)		0.58		mA	All Input 0V
	I _{DD2} (Q0)		1.18		mA	
	I _{DD1} (Q1)		2.92		mA	All Input at supply
	I _{DD2} (Q1)		1.24		mA	
	I _{DD1} (1M)		1.71		mA	All Input with 1Mbps, C _L =15pF
	I _{DD2} (1M)		1.38		mA	
	I _{DD1} (10M)		1.78		mA	All Input with 10Mbps, C _L =15pF
	I _{DD2} (10M)		3.2		mA	
	I _{DD1} (100M)		2.10		mA	All Input with 100Mbps, C _L =15pF
	I _{DD2} (100M)		21.0		mA	
	NSi8121/ NSi8122					
	I _{DD1} (Q0)		1.03		mA	All Input 0V
	I _{DD2} (Q0)		1.00		mA	
	I _{DD1} (Q1)		2.20		mA	All Input at supply
	I _{DD2} (Q1)		2.13		mA	
	I _{DD1} (1M)		1.72		mA	All Input with 1Mbps, C _L =15pF
	I _{DD2} (1M)		1.68		mA	
	I _{DD1} (10M)		2.62		mA	All Input with 10Mbps, C _L =15pF
I _{DD2} (10M)		2.71		mA		
I _{DD1} (100M)		11.01		mA	All Input with 100Mbps, C _L = 15pF	
I _{DD2} (100M)		12.8		mA		
Data Rate	DR	0		150	Mbps	
Minimum Pulse Width	PW			5.0	ns	
Propagation Delay	t _{PLH}		9.0		ns	
	t _{PHL}		9.0		ns	
Pulse Width Distortion	PWD			5.0	ns	t _{PHL} - t _{PLH}
Rising Time	t _r			5.0	ns	C _L = 15pF
Falling Time	t _f			5.0	ns	C _L = 15pF
Peak Eye Diagram Jitter	t _{JIT} (PK)		350		ps	

NSi8120/NSi8121/NSi8122

Channel-to-Channel Delay Skew	$t_{sk(c2c)}$			2.5	ns	
Part-to-Part Delay Skew	$t_{sk(p2p)}$			5.0	ns	

(VDD1=3.3V± 10%, VDD2=3.3V± 10%, Ta=-40°C to 125°C. Unless otherwise noted, Typical values are at VDD1 = 3.3V, VDD2 = 3.3V, Ta = 25°C)

Parameters	Symbol	Min	Typ	Max	Unit	Comments
Supply current	NSi8120					
	$I_{DD1}(Q0)$		0.55		mA	All Input 0V
	$I_{DD2}(Q0)$		1.12		mA	
	$I_{DD1}(Q1)$		2.87		mA	All Input at supply
	$I_{DD2}(Q1)$		1.18		mA	
	$I_{DD1}(1M)$		1.7		mA	All Input with 1Mbps, $C_L = 15pF$
	$I_{DD2}(1M)$		1.27		mA	
	$I_{DD1}(10M)$		1.73		mA	All Input with 10Mbps, $C_L = 15pF$
	$I_{DD2}(10M)$		2.41		mA	
	$I_{DD1}(100M)$		2.05		mA	All Input with 100Mbps, $C_L = 15pF$
	$I_{DD2}(100M)$		14.05		mA	
	NSi8121/ NSi8122					
	$I_{DD1}(Q0)$		0.98		mA	All Input 0V
	$I_{DD2}(Q0)$		0.95		mA	
	$I_{DD1}(Q1)$		2.14		mA	All Input at supply
	$I_{DD2}(Q1)$		2.08		mA	
	$I_{DD1}(1M)$		1.63		mA	All Input with 1Mbps, $C_L = 15pF$
	$I_{DD2}(1M)$		1.59		mA	
	$I_{DD1}(10M)$		2.22		mA	All Input with 10Mbps, $C_L = 15pF$
	$I_{DD2}(10M)$		2.25		mA	
$I_{DD1}(100M)$		7.57		mA	All Input with 100Mbps, $C_L = 15pF$	
$I_{DD2}(100M)$		8.5		mA		
Data Rate	DR	0		150	Mbps	
Minimum Pulse Width	PW			5.0	ns	
Propagation Delay	t_{PLH}		9.0		ns	
	t_{PHL}		9.0		ns	
Pulse Width Distortion	PWD			5.0	ns	$ t_{PHL} - t_{PLH} $

NSi8120/NSi8121/NSi8122

Rising Time	t_r			5.0	ns	$C_L = 15\text{pF}$
Falling Time	t_f			5.0	ns	$C_L = 15\text{pF}$
Peak Eye Diagram Jitter	$t_{JIT(PK)}$		350		ps	
Channel-to-Channel Delay Skew	$t_{sk(c2c)}$			2.5	ns	
Part-to-Part Delay Skew	$t_{sk(p2p)}$			5.0	ns	

(VDD1=2.5V± 10%, VDD2=2.5V± 10%, Ta=-40°C to 125°C. Unless otherwise noted, Typical values are at VDD1 = 2.5V, VDD2 = 2.5V, Ta = 25°C)

Parameters	Symbol	Min	Typ	Max	Unit	Comments
Supply current	NSi8120					
	$I_{DD1(Q0)}$		0.53		mA	All Input 0V
	$I_{DD2(Q0)}$		1.1		mA	
	$I_{DD1(Q1)}$		2.85		mA	All Input at supply
	$I_{DD2(Q1)}$		1.15		mA	
	$I_{DD1(1M)}$		1.63		mA	All Input with 1Mbps, $C_L = 15\text{pF}$
	$I_{DD2(1M)}$		1.21		mA	
	$I_{DD1(10M)}$		1.68		mA	All Input with 10Mbps, $C_L = 15\text{pF}$
	$I_{DD2(10M)}$		2.05		mA	
	$I_{DD1(100M)}$		1.95		mA	All Input with 100Mbps, $C_L = 15\text{pF}$
	$I_{DD2(100M)}$		10.4		mA	
	NSi8121/ NSi8122					
	$I_{DD1(Q0)}$		0.96		mA	All Input 0V
	$I_{DD2(Q0)}$		0.93		mA	
	$I_{DD1(Q1)}$		2.11		mA	All Input at supply
	$I_{DD2(Q1)}$		2.05		mA	
	$I_{DD1(1M)}$		1.58		mA	All Input with 1Mbps, $C_L = 15\text{pF}$
	$I_{DD2(1M)}$		1.54		mA	
	$I_{DD1(10M)}$		2.02		mA	All Input with 10Mbps, $C_L = 15\text{pF}$
	$I_{DD2(10M)}$		2.04		mA	
$I_{DD1(100M)}$		6.03		mA	All Input with 100Mbps, $C_L = 15\text{pF}$	
$I_{DD2(100M)}$		6		mA		
Data Rate	DR	0		150	Mbps	
Minimum Pulse Width	PW			5.0	ns	

NSi8120/NSi8121/NSi8122

Propagation Delay	t_{PLH}		10		ns	
	t_{PHL}		10		ns	
Pulse Width Distortion	PWD			5.0	ns	$ t_{PHL} - t_{PLH} $
Rising Time	t_r			5.0	ns	$C_L = 15pF$
Falling Time	t_f			5.0	ns	$C_L = 15pF$
Peak Eye Diagram Jitter	$t_{JIT(PK)}$		350		ps	
Channel-to-Channel Delay Skew	$t_{SK(c2c)}$			2.5	ns	
Part-to-Part Delay Skew	$t_{SK(p2p)}$			5.0	ns	

2.2. TYPICAL PERFORMANCE CHARACTERISTICS

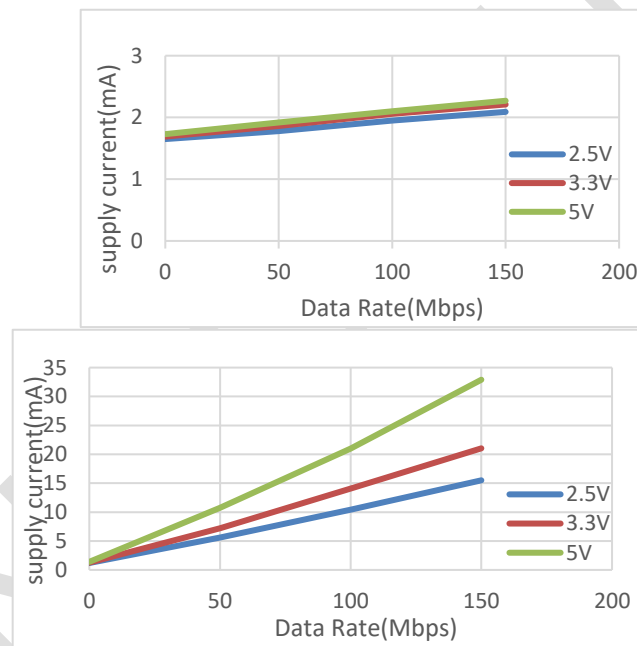


Figure 2.1 NSi8120 VDD1 Supply Current vs Data Rate

Figure 2.2 NSi8120 VDD2 Supply Current vs Data Rate

NSi8120/NSi8121/NSi8122

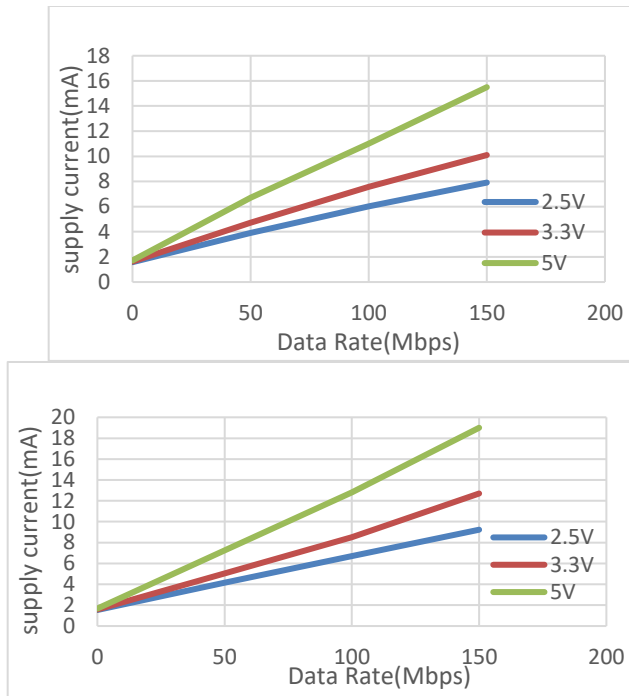


Figure 2.3 NSi8121/ NSi8122 VDD1 Supply Current vs Data Rate Figure 2.4 NSi8121/ NSi8122 VDD2 Supply Current vs Data Rate

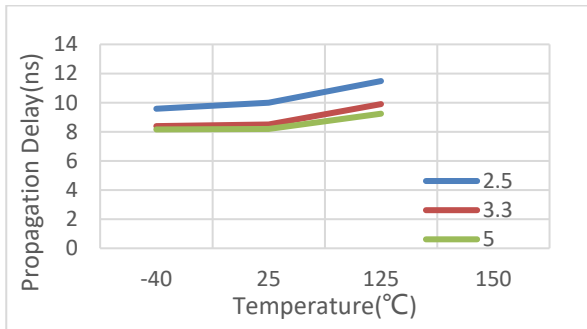


Figure 2.5 Propagation Delay vs Temperature

2.3. PARAMETER MEASUREMENT INFORMATION

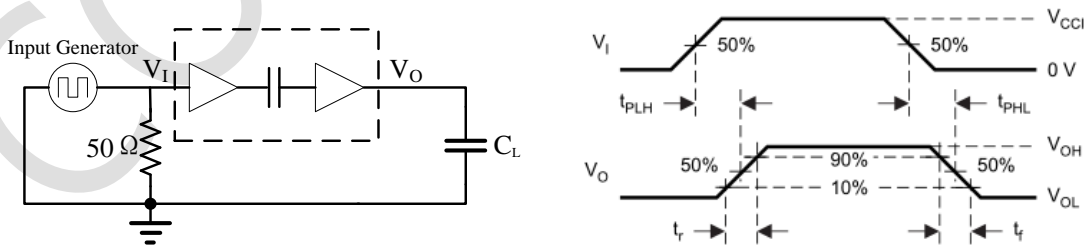


Figure 2.6 Switching Characteristic Test Circuit and Voltage Waveforms

NSi8120/NSi8121/NSi8122

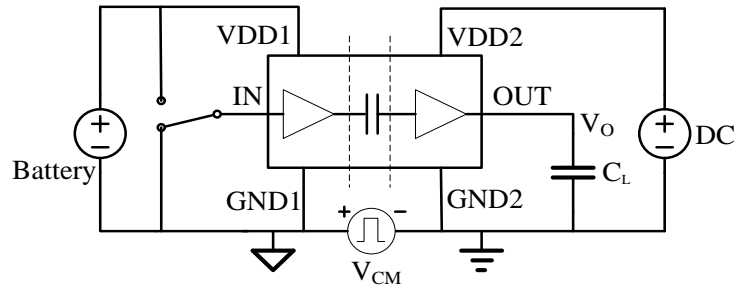


Figure 2.7 Common-Mode Transient Immunity Test Circuit

3.0 HIGH VOLTAGE FEATURE DESCRIPTION

3.1. INSULATION AND SAFETY RELATED SPECIFICATIONS

Parameters	Symbol	Value		Unit	Comments
		SOIC-8	SOIC-16		
Minimum External Air Gap (Clearance)	L(I01)	4.0	7.8	mm	Shortest terminal-to-terminal distance through air
Minimum External Tracking (Creepage)	L(I02)	4.0	7.8	mm	Shortest terminal-to-terminal distance across the package surface
Minimum internal gap	DTI	20		um	Distance through insulation
Tracking Resistance(Comparative Tracking Index)	CTI	>600		V	DIN EN 60112 (VDE 0303-11); IEC 60112
Material Group		I			

3.2. DIN VDE V 0884-10 (VDE V 0884-10) INSULATION CHARACTERISTICS

Description	Test Condition	Symbol	Value		Unit
			SOIC-8	SOIC-16	
Installation Classification per DIN VDE 0110			SOIC-8	SOIC-16	
For Rated Mains Voltage ≤ 150 Vrms			I to IV	I to IV	
For Rated Mains Voltage ≤ 300 Vrms			I to III	I to IV	
For Rated Mains Voltage ≤ 400 Vrms			I to III	I to IV	
Climatic Classification			10/105/21	10/105/21	
Pollution Degree per DIN VDE 0110, Table 1			2	2	
Maximum repetitive isolation voltage		VIORM	565	849	Vpeak

NSi8120/NSi8121/NSi8122

Input to Output Test Voltage, Method B1	$V_{IORM} \times 1.875 = V_{pd(m)}$, 100% production test, $t_{ini} = t_m = 1$ sec, partial discharge < 5 pC	$V_{pd(m)}$	1059	1592	Vpeak
Input to Output Test Voltage, Method A					
After Environmental Tests Subgroup 1	$V_{IORM} \times 1.5 = V_{pd(m)}$, $t_{ini} = 60$ sec, $t_m = 10$ sec, partial discharge < 5 pC	$V_{pd(m)}$	848	1274	Vpeak
After Input and /or Safety Test Subgroup 2 and Subgroup 3	$V_{IORM} \times 1.2 = V_{pd(m)}$, $t_{ini} = 60$ sec, $t_m = 10$ sec, partial discharge < 5 pC	$V_{pd(m)}$	678	1019	Vpeak
Maximum transient isolation voltage	$t = 60$ sec	VIOTM	5300	7000	Vpeak
Maximum Surge Isolation Voltage	Test method per IEC60065, 1.2/50us waveform, $V_{TEST} = 1.6$ $\times V_{IOSM}$	VIOSM	6000	7000	Vpeak
Isolation resistance	$V_{IO} = 500V$	RIO	$>10^9$	$>10^9$	Ω
Isolation capacitance	$f = 1MHz$	CIO	0.8	0.8	pF
Input capacitance		CI	2	2	pF
Total Power Dissipation at 25°C		Ps		1499	mW
Safety input, output, or supply current	$\theta_{JA} = 140$ °C/W, $V_I = 5.5$ V, $T_J = 150$ °C, $T_A = 25$ °C	Is	160		mA
	$\theta_{JA} = 84$ °C/W, $V_I = 5.5$ V, $T_J = 150$ °C, $T_A = 25$ °C			237	mA
Case Temperature		Ts	150	150	°C

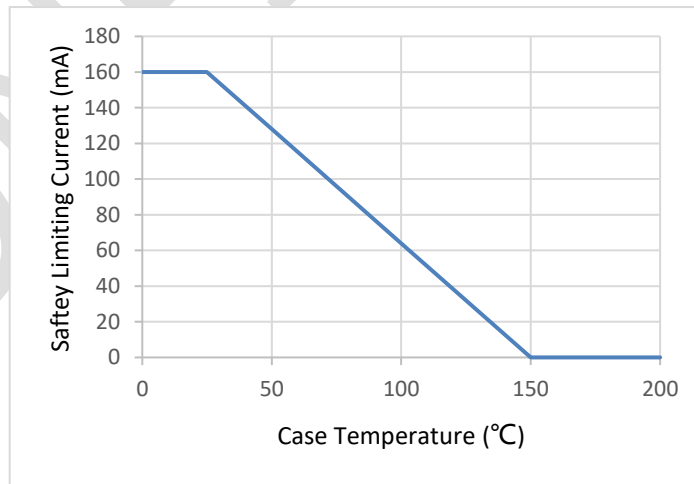


Figure 3.1 NSi8120N/NSi8121N/NSi8122N Thermal Derating Curve, Dependence of Safety Limiting Values with Case Temperature per DIN V VDE V 0884-10

NSi8120/NSi8121/NSi8122

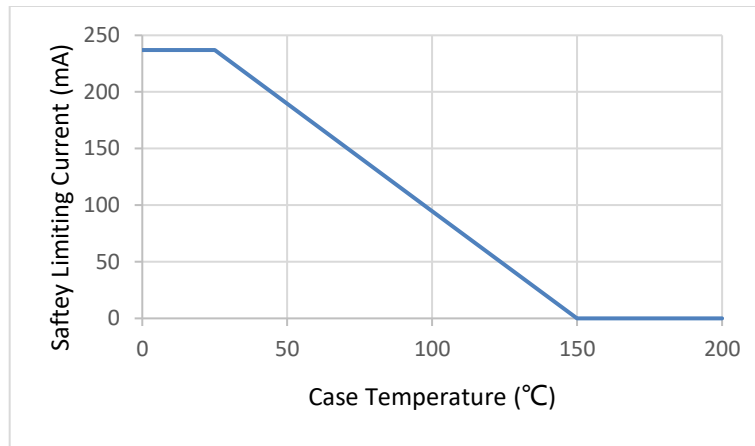


Figure 3.2 NSi8120W/NSi8121W/NSi8122W Thermal Derating Curve, Dependence of Safety Limiting Values with Case Temperature per DIN V VDE V 0884-10

3.3. REGULATORY INFORMATION

The NSi8120N/NSi8121N/NSi8122N are approved or pending approval by the organizations listed in table.

UL	CSA	VDE	CQC
UL 1577 Component Recognition Program ¹	Approved under CSA Component Acceptance Notice 5A IEC60950-1	DIN V VDE V0884-10 (VDE V 0884-10):2006-12 ²	Certified by CQC11-471543-2012 GB4943.1-2011
Single Protection, 3750Vrms Isolation voltage	400V _{RMS} basic insulation working voltage	Basic Insulation 565Vpeak, V _{IOSM} =6000Vpeak	Basic insulation at 400V _{RMS} (565Vpeak)
File (pending)	File (pending)	File (pending)	File (pending)

¹ In accordance with UL 1577, each NSi8120N/NSi8121N/NSi8122N is proof tested by applying an insulation test voltage ≥ 4500 V rms for 1 sec.

² In accordance with DIN V VDE V 0884-10, each NSi8120N/NSi8121N/NSi8122N is proof tested by applying an insulation test voltage ≥ 1059 V peak for 1 sec (partial discharge detection limit = 5 pC). The * marking branded on the component designates DIN V VDE V 0884-10 approval.

The NSi8120W/NSi8121W/NSi8122W are approved or pending approval by the organizations listed in table.

UL	CSA	VDE	CQC
UL 1577 Component Recognition Program	Approved under CSA Component Acceptance Notice 5A IEC60950-1	DIN V VDE V0884-10 (VDE V 0884-10):2006-12	Certified by CQC11-471543-2012 GB4943.1-2011
Double Protection, 5000Vrms Isolation voltage	780V _{RMS} basic insulation working voltage 390V _{RMS} Reinforced insulation working voltage	Basic Insulation 849Vpeak, V _{IOSM} =7000Vpeak	Basic insulation at 780V _{RMS} (1103Vpeak) Reinforced insulation at 390V _{RMS} (552Vpeak)
File (pending)	File (pending)	File (pending)	File (pending)

¹ In accordance with UL 1577, each NSi8120W/NSi8121W/NSi8122W is proof tested by applying an insulation test voltage ≥ 6000 V rms for 1 sec.

² In accordance with DIN V VDE V 0884-10, each NSi8120W/NSi8121W/NSi8122W is proof tested by applying an insulation test voltage ≥ 1592 V peak for 1 sec (partial discharge detection limit = 5 pC). The * marking branded on the component designates DIN V VDE V 0884-10 approval.

4.0 FUNCTION DESCRIPTION

The NSi812x is a Dual-channel digital isolator based on a capacitive isolation barrier technique. The digital signal is modulated with RF carrier generated by the internal oscillator at the Transmitter side. Then it is transferred through the capacitive isolation barrier and demodulated at the Receiver side.

The NSi812x devices are high reliability dual-channel digital isolator with AEC-Q100 qualified. The NSi812x device is safety certified by UL1577 support several insulation withstand voltages (3.75kVrms, 5kVrms), while providing high electromagnetic immunity and low emissions at low power consumption. The data rate of the NSi812x is up to 150Mbps, and the common-mode transient immunity (CMTI) is up to 150kV/us. The NSi812x device provides digital channel direction configuration and the default output level configuration when the input power is lost. Wide supply voltage of the NSi812x device support to connect with most digital interface directly, easy to do the level shift. High system level EMC performance enhance reliability and stability of use.

The NSi812x has a default output status when VDDIN is unready and VDDOUT is ready as shown in Table 4.1, which helps for diagnosis when power is missing at the transmitter side. The output B follows the same status with the input A within 1us after powering up.

Table 4.1 Output status vs. power status

Input	VDD1 status	VDD2 status	Output	Comment
H	Ready	Ready	H	Normal operation.
L	Ready	Ready	L	
X	Unready	Ready	L H	The output follows the same status with the input within 1us after input side VDD1 is powered on.
X	Ready	Unready	X	The output follows the same status with the input within 1us after output side VDD2 is powered on.

5.0 APPLICATION NOTE

5.1. PCB LAYOUT

The NSi812x requires a 0.1 μ F bypass capacitor between VDD1 and GND1, VDD2 and GND2. The capacitor should be placed as close as possible to the package. Figure 5.1 to Figure 5.4 show the recommended PCB layout, make sure the space under the chip should keep free from planes, traces, pads and via. To enhance the robustness of a design, the user may also include resistors (50–300 Ω) in series with the inputs and outputs if the system is excessively noisy. The series resistors also improve the system reliability such as latch-up immunity.

The typical output impedance of an isolator driver channel is approximately 50 Ω , $\pm 40\%$. When driving loads where transmission line effects will be a factor, output pins should be appropriately terminated with controlled impedance PCB traces.

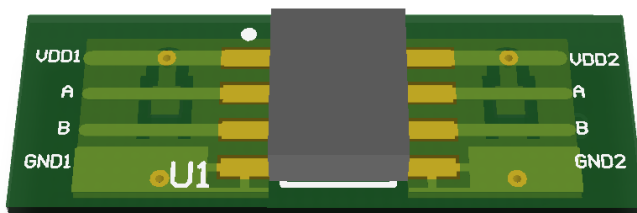


Figure5.1 Recommended PCB Layout — Top Layer



Figure5.2 Recommended PCB Layout — Bottom Layer

NSi8120/NSi8121/NSi8122

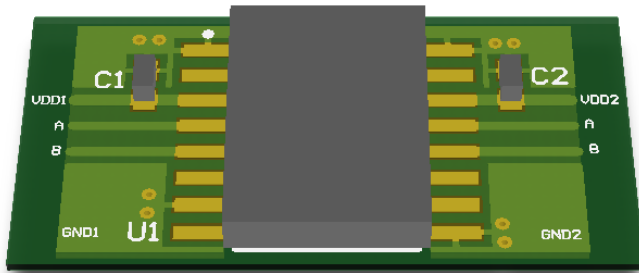


Figure 5.3 Recommended PCB Layout — Top Layer



Figure 5.4 Recommended PCB Layout — Bottom Layer

5.2. HIGH SPEED PERFORMANCE

Figure 5.5 shows the eye diagram of NSi812x at 200Mbps data rate output. The result shows a typical measurement on the NSi812x with 350ps p-p jitter.

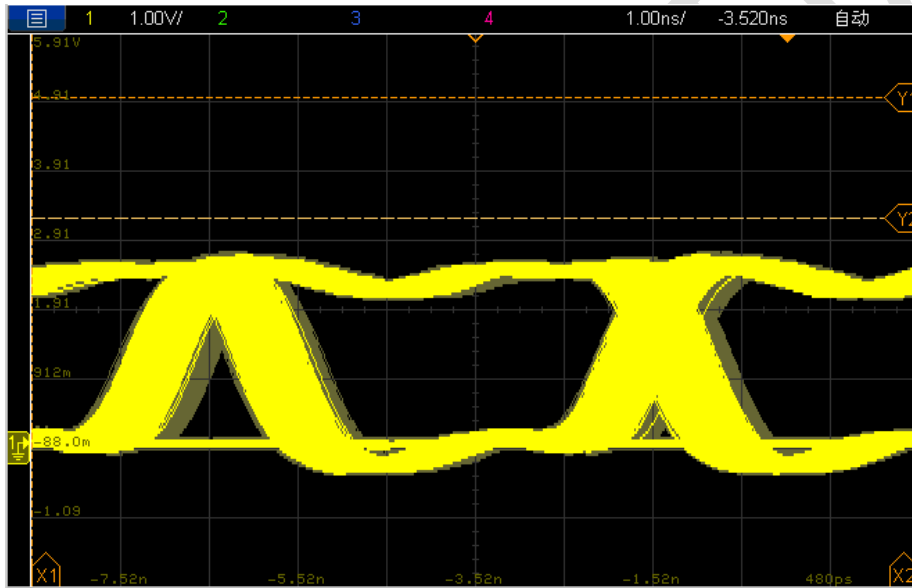


Figure 5.5 NSi812x Eye Diagram

5.3. TYPICAL SUPPLY CURRENT EQUATIONS

The typical supply current of NSi812x can be calculated using below equations. I_{DD1} and I_{DD2} are typical supply currents measured in mA, f is data rate measured in Mbps, C_L is the capacitive load measured in pF

NSi8120:

$$I_{DD1} = 0.19 * a1 + 1.45 * b1 + 0.82 * c1.$$

$$I_{DD2} = 1.36 + VDD1 * f * C_L * c1 * 10^{-9}$$

When $a1$ is the channel number of low input at side 1, $b1$ is the channel number of high input at side 1, $c1$ is the channel number of switch signal input at side 1.

NSi8121/ NSi8122:

$$I_{DD1} = 0.87 + 1.26 * b1 + 0.63 * c1 + VDD1 * f * C_L * c2 * 10^{-9}$$

$$I_{DD2} = 0.87 + 1.26 * b2 + 0.63 * c2 + VDD1 * f * C_L * c1 * 10^{-9}$$

When $b1$ is the channel number of high input at side 1, $c1$ is the channel number of switch signal input at side 1, $b2$ is the channel number of high input at side 2, $c2$ is the channel number of switch signal input at side 2.

6.0 PACKAGE INFORMATION

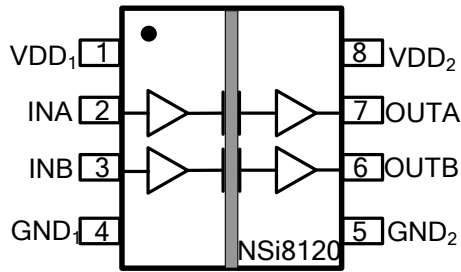


Figure 6.1 NSi8120N Package

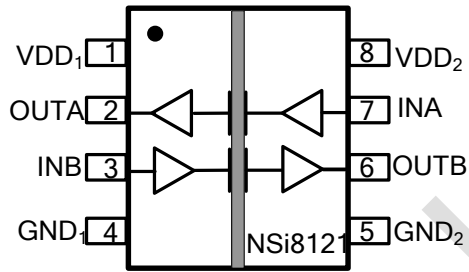


Figure 6.2 NSi8121N Package

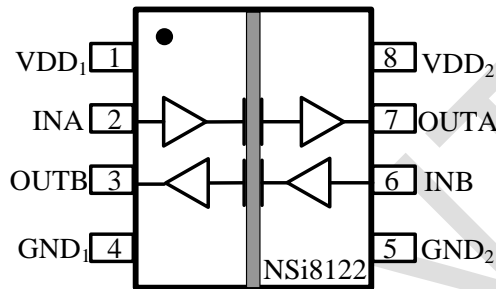


Figure 6.3 NSi8122N Package

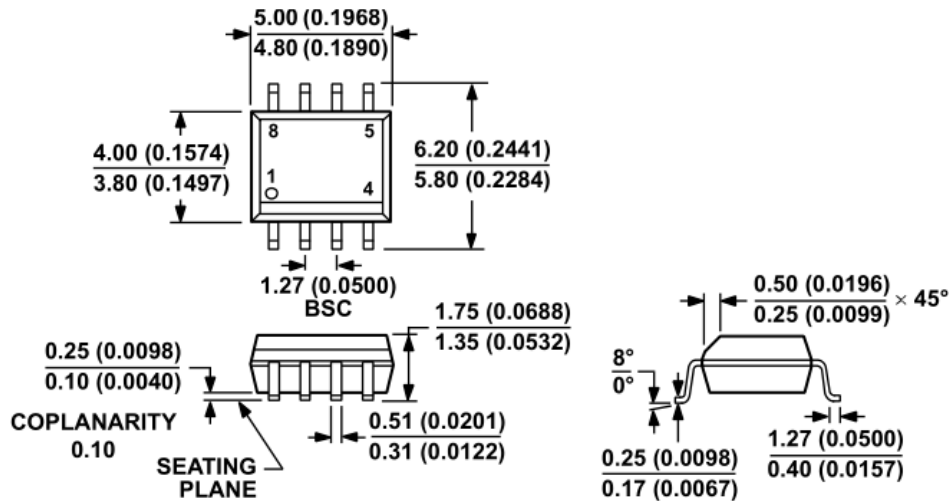


Figure 6.4 SOIC8 Package Shape and Dimension in millimeters (inches)

Table 6.1 NSi8120N/ NSi8121N/ NSi8122N Pin Configuration and Description

<i>NSi8120N</i> PIN NO.	<i>NSi8121N</i> PIN NO.	<i>NSi8122N</i> PIN NO.	<i>SYMBOL</i>	<i>FUNCTION</i>
1	1	1	VDD1	Power Supply for Isolator Side 1
2	7	2	INA	Logic Input A
3	3	6	INB	Logic Input B
4	4	4	GND1	Ground 1, the ground reference for Isolator Side 1

NSi8120/NSi8121/NSi8122

5	5	5	GND2	Ground 2, the ground reference for Isolator Side 2
6	6	3	OUTB	Logic Output B
7	2	7	OUTA	Logic Output A
8	8	8	VDD2	Power Supply for Isolator Side 2

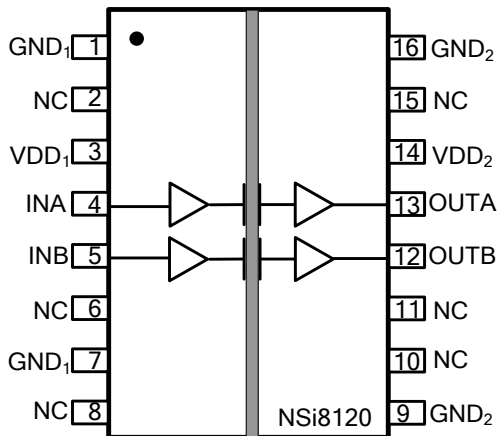


Figure 6.5 NSi8120W Package

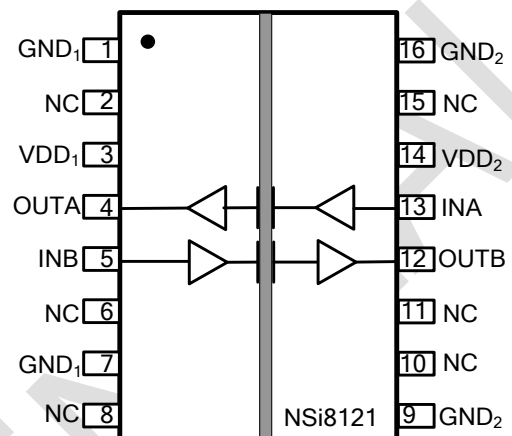


Figure 6.6 NSi8121W Package

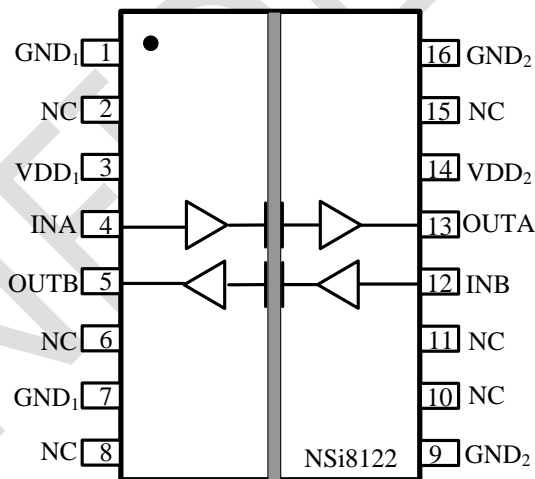


Figure 6.7 NSi8122W Package

NSi8120/NSi8121/NSi8122

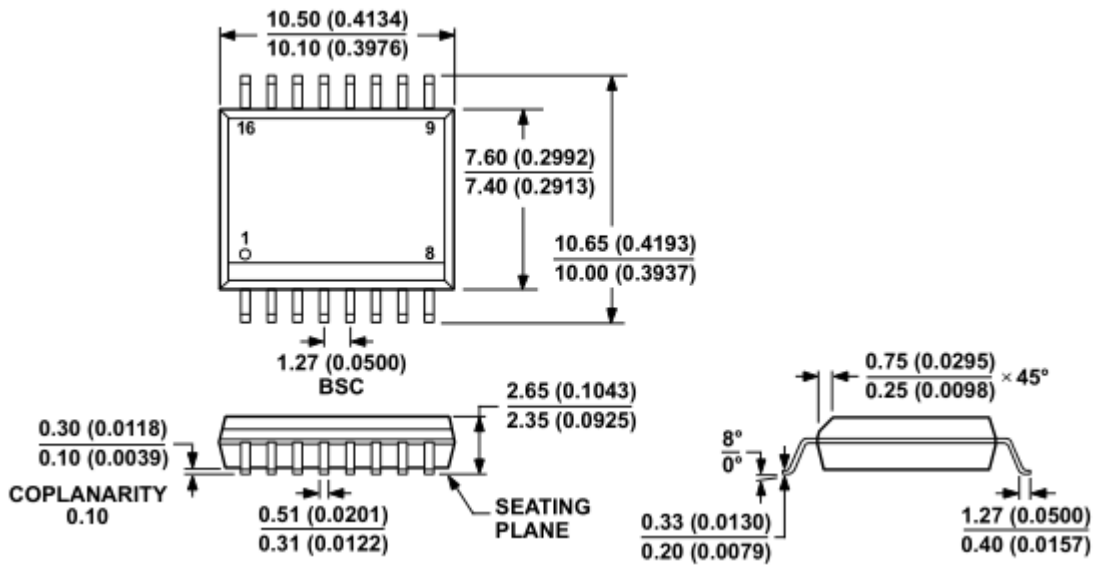


Figure 6.8 WB SOIC16 Package Shape and Dimension in millimeters and (inches)

Table 6.2 NSi8120W/ NSi8121W/ NSi8122W Pin Configuration and Description

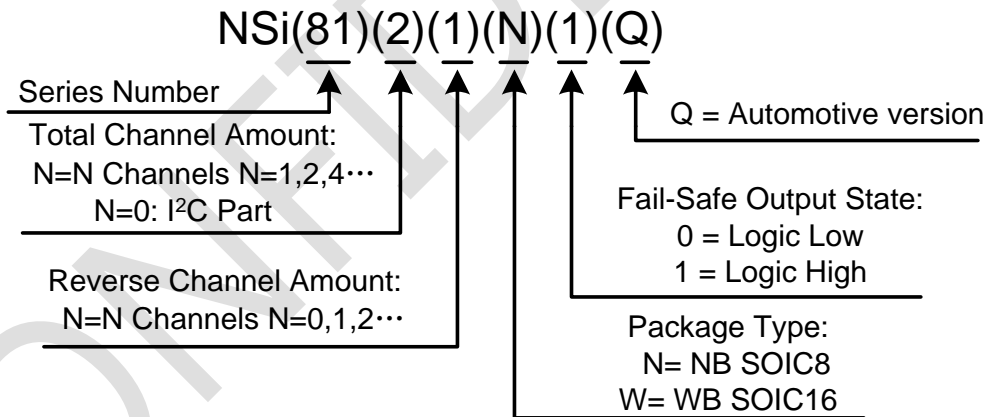
<i>NSi8120W</i> PIN NO.	<i>NSi8121W</i> PIN NO.	<i>NSi8122W</i> PIN NO.	<i>SYMBOL</i>	<i>FUNCTION</i>
1	1	1	GND1	Ground 1, the ground reference for Isolator Side 1
2	2	2	NC	No Connection.
3	3	3	VDD1	Power Supply for Isolator Side 1
4	13	4	INA	Logic Input A
5	5	12	INB	Logic Input B
6	6	6	NC	No Connection.
7	7	7	GND1	Ground 1, the ground reference for Isolator Side 1
8	8	8	NC	No Connection.
9	9	9	GND2	Ground 2, the ground reference for Isolator Side 2
10	10	10	NC	No Connection.
11	11	11	NC	No Connection.
12	12	5	OUTB	Logic Output A
13	4	13	OUTA	Logic Output B
14	14	14	NC	No Connection.
15	15	15	VDD2	Power Supply for Isolator Side 2
16	16	16	GND2	Ground 2, the ground reference for Isolator Side 2

NSi8120/NSi8121/NSi8122

7.0 ORDER INFORMATION

Part No.	Isolation Rating(kV)	Number of side 1 inputs	Number of side 2 inputs	Max Data Rate (Mbps)	Default Output State	Temperature	Automotive	Package
NSi8120N0	3.75	2	0	150	Low	-40 to 125°C	NO	SOIC8
NSi8120N1	3.75	2	0	150	High	-40 to 125°C	NO	SOIC8
NSi8121N0	3.75	1	1	150	Low	-40 to 125°C	NO	SOIC8
NSi8121N1	3.75	1	1	150	High	-40 to 125°C	NO	SOIC8
NSi8122N0	3.75	1	1	150	Low	-40 to 125°C	NO	SOIC8
NSi8122N1	3.75	1	1	150	High	-40 to 125°C	NO	SOIC8
NSi8120W0	5	2	0	150	Low	-40 to 125°C	NO	WB SOIC16
NSi8120W1	5	2	0	150	High	-40 to 125°C	NO	WB SOIC16
NSi8121W0	5	1	1	150	Low	-40 to 125°C	NO	WB SOIC16
NSi8121W1	5	1	1	150	High	-40 to 125°C	NO	WB SOIC16
NSi8122W0	5	1	1	150	Low	-40 to 125°C	NO	WB SOIC16
NSi8122W1	5	1	1	150	High	-40 to 125°C	NO	WB SOIC16
NSi8120N0Q	3.75	2	0	150	Low	-40 to 125°C	YES	SOIC8
NSi8120N1Q	3.75	2	0	150	High	-40 to 125°C	YES	SOIC8
NSi8121N0Q	3.75	1	1	150	Low	-40 to 125°C	YES	SOIC8
NSi8121N1Q	3.75	1	1	150	High	-40 to 125°C	YES	SOIC8
NSi8122N0Q	3.75	1	1	150	Low	-40 to 125°C	YES	SOIC8
NSi8122N1Q	3.75	1	1	150	High	-40 to 125°C	YES	SOIC8

Part Number Rule:



8.0 REVISION HISTORY

Revision	Description	Date
1.0		2017/11/15
1.3		2018/8/21

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